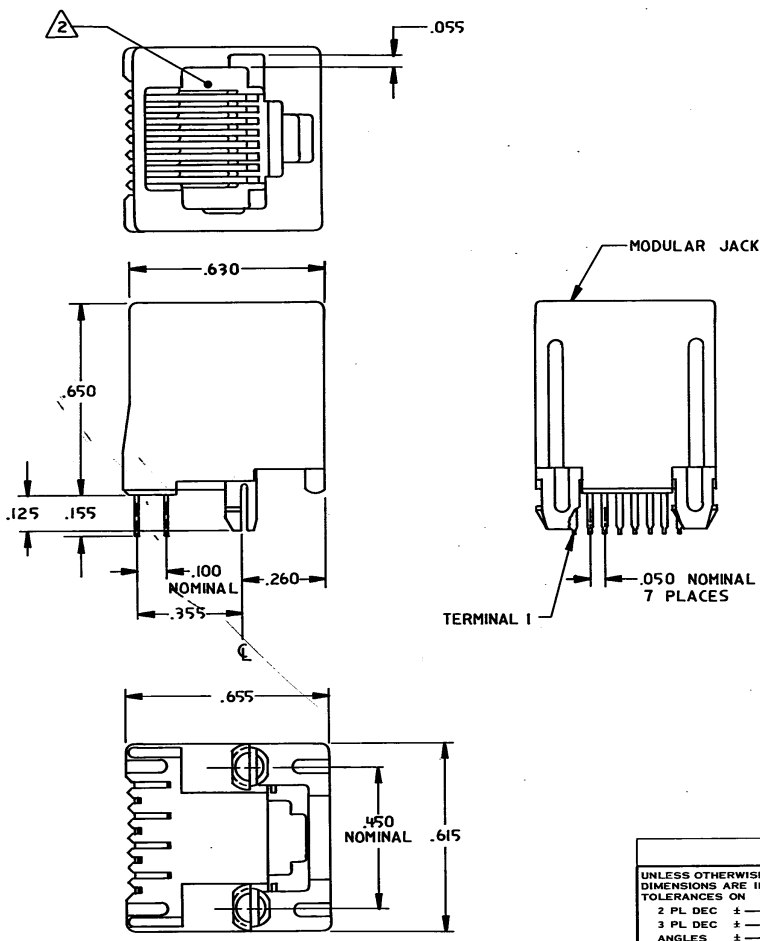


DRAWING MADE IN THIRD ANGLE PROJECTION
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LOC	DIST	ZONE	LTR	REVISIONS	DATE	APPD
AA	22			C	REV: ECN 0210-10-93	3-22-93



- 1 MATERIAL: HOUSING—PBT POLYESTER, BLACK. TERMINAL—.0138 THICK PHOS BRONZE PLATED WITH .000050 THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND .000080 THICK TIN-LEAD IN SOLDER AREA OVER .000050 THICK NICKEL UNDERPLATE.
- 2 CAVITY CONFORMS TO FFC RULES AND REGULATIONS PART 68 AND REA BULLETIN 345-81, PE-76 SPECIFICATION FOR MODULAR TELEPHONE HARDWARE.
- 3. FOR APPLICATION INFORMATION SEE AMP SPECIFICATION 114-2048.
- 4. FOR PERFORMANCE REQUIREMENTS SEE AMP SPECIFICATION 108-1163.
- 5. ALL DIMENSIONS SHOWN ARE MAXIMUM UNLESS OTHERWISE SPECIFIED.

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES		DR <i>Tom Woodall</i> 6-8-88	555799-1	
TOLERANCES ON		CHK <i>Bill Bell</i> 6-13-88	PART NO	
2 PL DEC ±		APPD <i>Gene Reed</i> 6-14-88	AMP AMP INCORPORATED Harrisburg, Pa. 17105	
3 PL DEC ±		APPD <i>DAI</i> 6-19-88	NAME	
ANGLES ±		PRODUCT SPEC	PRINTED CIRCUIT BOARD MODULAR JACK ASSEMBLY, TOP ENTRY, 8 POSITION, KEYED, FLANGELESS W/O PANEL STOPS	
MATERIAL	APPLICATION SPEC	SIZE	FSCM NO	DRAWING NO
△		C	00779	555799
FINISH	WEIGHT	SCALE	SHEET 1 OF 1	
△		4:1		

CUSTOMER DRAWING